#### PD-95023C

# International TOR Rectifier

## IRF7811WPbF

## **HEXFET® Power MOSFET for DC-DC Converters**

- N-Channel Application-Specific MOSFETs
- Ideal for CPU Core DC-DC Converters
- Low Conduction Losses
- · Low Switching Losses
- 100% Tested for Rg
- Lead-Free

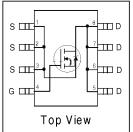
#### Description

This new device employs advanced HEXFET Power MOSFET technology to achieve an unprecedented balance of on-resistance and gate charge. The reduced conduction and switching losses make it ideal for high efficiency DC-DC converters that power the latest generation of microprocessors.

The IRF7811WPbF has been optimized for all parameters that are critical in synchronous buck converters including  $R_{\rm DS(on)}$ , gate charge and Cdv/dt-induced turn-on immunity. The IRF7811WPbF offers particulary low  $R_{\rm DS(on)}$  and high Cdv/dt immunity for synchronous FET applications.

The package is designed for vapor phase, infra-red, convection, or wave soldering techniques. Power dissipation of greater than 3W is possible in a typical PCB mount application.





#### **DEVICE CHARACTERISTICS** ⑤

	IRF7811WPbF							
R <sub>DS(on)</sub>	$9.0 \mathrm{m}\Omega$							
$Q_{_{G}}$	22nC							
$Q_{_{\mathrm{sw}}}$	10.1nC							
Q <sub>oss</sub>	12nC							

#### **Absolute Maximum Ratings**

Parameter		Symbol	IRF7811WPbF	Units
Drain-Source Voltage		V <sub>DS</sub>	30	V
Gate-Source Voltage		$V_{GS}$	±12	
Continuous Drain or Source	T <sub>A</sub> = 25°C	I <sub>D</sub>	14	
Current (V <sub>GS</sub> ≥ 4.5V)	T <sub>L</sub> = 90°C		13	A
Pulsed Drain Current①		I <sub>DM</sub>	109	
Power Dissipation	T <sub>A</sub> = 25°C	$P_{D}$	3.1	W
	T <sub>L</sub> = 90°C		3.0	
Junction & Storage Temperate	ure Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C
Continuous Source Current (E	Body Diode)	Is	3.8	А
Pulsed Source Current①		I <sub>SM</sub>	109	

#### Thermal Resistance

Parameter		Max.	Units
Maximum Junction-to-Ambient®	R <sub>eJA</sub>	40	°C/W
Maximum Junction-to-Lead	R <sub>oul</sub>	20	°C/W

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#### **Electrical Characteristics**

Parameter		Min	Тур	Max	Units	Conditions
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-	-	V	$V_{CS} = 0V$ , $I_D = 250\mu A$
Static Drain-Source on Resistance	R <sub>DS(on)</sub>		9.0	12	mΩ	$V_{GS} = 4.5 \text{V}, I_{D} = 15 \text{A} \odot$
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0			V	$V_{DS} = V_{GS}, I_D = 250\mu A$
Drain-Source Leakage Current	I <sub>DSS</sub>			30		$V_{DS} = 24V, V_{GS} = 0$
				150	μА	$V_{DS} = 24V, V_{GS} = 0,$
Gate-Source Leakage Current	I <sub>GSS</sub>			±100	nA	$Tj = 100^{\circ}C$ $V_{OS} = \pm 12V$
Total Gate Chg Cont FET	Q <sub>G</sub>		22	33		V <sub>GS</sub> =5.0V, I <sub>D</sub> =15A, V <sub>DS</sub> =16V
Total Gate Chg Sync FET	Q <sub>G</sub>		16.3			$V_{OS} = 5V, V_{DS} < 100 \text{mV}$
Pre-Vth Gate-Source Charge	Q <sub>GS1</sub>		3.5			$V_{DS} = 16V, I_{D} = 15A, V_{GS} = 5.0V$
Post-Vth Gate-Source Charge	Q <sub>GS2</sub>		1.2		nC	
Gate to Drain Charge	$Q_{GD}$		8.8			
Switch Chg(Q <sub>qs2</sub> + Q <sub>qd</sub> )	Q <sub>sw</sub>		10.1			
Output Charge	Q <sub>oss</sub>		12			V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0
Gate Resistance	$R_{G}$		2.0	4.0	Ω	
Turn-on Delay Time	t <sub>d (on)</sub>		11			$V_{DD} = 16V, I_{D} = 15A$
Rise Time	ţ		11		ns	V <sub>GS</sub> = 5.0V
Turn-off Delay Time	t <sub>d (off)</sub>		29			Clamped Inductive Load
Fall Time	t <sub>f</sub>		9.9			
Input Capacitance	C <sub>iss</sub>	-	2335	-		
Output Capacitance	Coss	-	400	-	рF	$V_{DS} = 16V, V_{GS} = 0$
Reverse Transfer Capacitano	ce C <sub>rss</sub>	_	119	_		

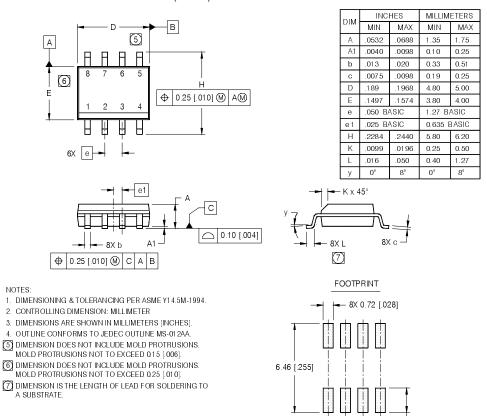
### Source-Drain Rating & Characteristics

Parameter		Min	Тур	Max	Units	Conditions
Diode Forward Voltage*	V <sub>SD</sub>			1.25	٧	$I_{_{\rm S}} = 15 {\rm A} \odot,  V_{_{\rm OS}} = 0 {\rm V}$
Reverse Recovery Charge⊕	Q <sub>rr</sub>		45		nC	di/dt ~ 700A/ $\mu$ s V <sub>DS</sub> = 16V, V <sub>OS</sub> = 0V, I <sub>S</sub> = 15A
Reverse Recovery Charge (with Parallel Schottky)	Q <sub>rr(s)</sub>		41		nC	di/dt = $700A/\mu s$ (with 10BQ040) $V_{DS} = 16V$ , $V_{GS} = 0V$ , $I_{S} = 15A$

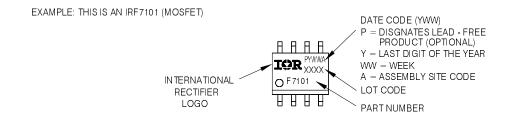
- Notes: 
   Repetitive rating; pulse width limited by max. junction temperature. 
   Pulse width  $\leq$  400 µs; duty cycle  $\leq$  2%. 
   When mounted on 1 inch square copper board 
   Typ = measured  $Q_{oss}$  
   Typical values of  $R_{DS}(on)$  measured at  $V_{GS} = 4.5V$ ,  $Q_{GS}$ ,  $Q_{SW}$  and  $Q_{OSS}$  measured at  $V_{GS} = 5.0V$ ,  $I_{F} = 15A$ .

## SO-8 Package Outline(Mosfet & Fetky)

Dimensions are shown in milimeters (inches)



## SO-8 Part Marking Information



3X 1.27 [.050] —

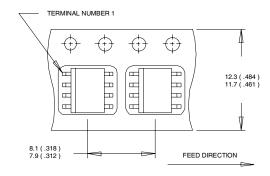
8X 1.78 [.070]

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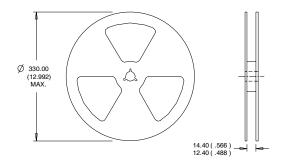
## **SO-8 Tape and Reel**

Dimensions are shown in millimeters (inches)



#### NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
  2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
  3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES:
  1. CONTROLLING DIMENSION: MILLIMETER.
  2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
  - Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market.

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